



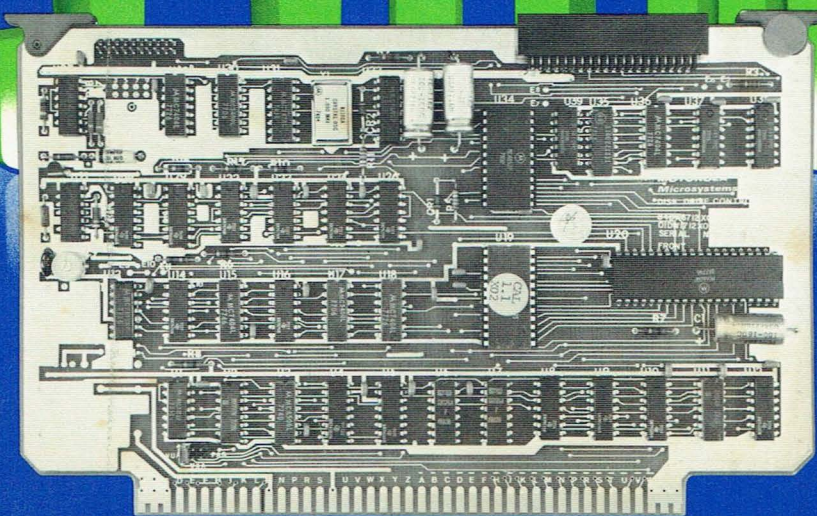
MOTOROLA

M68SFDC3(D3)

**M68SFDC
M68SFDC2
M68SFDC3
M6809FDCONT2
M6809FDCONT3
FLOPPY DISK CONTROLLER MODULE**

User's Guide

SYSTEMS



MICROSYSTEMS

**M68SFDC
M68SFDC2
M68SFDC3
M6809FDCONT2
M6809FDCONT3
FLOPPY DISK
CONTROLLER MODULE
USER'S GUIDE**

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CHAPTER 1

GENERAL INFORMATION

1.1 INTRODUCTION

This manual provides general information, preparation-for-use and installation instructions, programming considerations, theory of operation, adjustments, and illustrated parts list for the M68SFDC, M68SFDC2, M68SFDC3, M6809FDCONT2, and M6809FDCONT3 Floppy Disk Controller Modules. A typical module is shown in Figure 1-1. All address references within this manual are shown in hexadecimal unless otherwise indicated.

1.2 FEATURES

The features of the Floppy Disk Controller Module include:

- Ability to read and write double-sided, single-sided, or mixed media. (Version 3 only)
- Compatible with EXORciser I and II, and EXORterm.
- Operable from 940 KHz to 2 MHz. (Versions 2 and 3 only)
- Direct control of the EXORdisk II/III Disk Drive Units via Resident Driver Firmware.
- Formatting and control of synchronous serial data transferred between the EXORdisk II/III Disk Drive Units and the EXORciser or EXORterm.
- Direct interface with the EXORciser bus or the EXORterm bus.
- Fully compatible with MDOS (Motorola Disk Operating System) software.
- Series II DSB (Dynamic System Bus) provides Page Enable and Priority Interrupt Control. (Versions 2 and 3 only)
- Jumpers allow module to be addressed via VUA, VXA, or Page Enable. (Versions 2 and 3 only)
- TTL voltage-compatible high-impedance inputs.
- Capable of controlling up to four double-sided Disk Drives. (Version 3 only)

1.3 SPECIFICATIONS

The specifications for the Floppy Disk Controller Module are identified in Table 1-1.

1.4 GENERAL DESCRIPTION

The Floppy Disk Controller Module provides the disk drive control and data transfer functions for the EXORdisk II/III Floppy Disk Systems. This system includes the EXORdisk II/III Disk Drive Unit and the MDOS software. This module is bus-compatible with both the EXORciser and the EXORterm family.

The address allocation for the Floppy Disk Controller Module extends from E800 to EC07, inclusive. This range of memory addresses is divided into the following areas:

- E800 thru EBFF are assigned to the Resident Driver Firmware.
- EC00 thru EC03 are assigned to control the operation of the Disk Drive Unit.
- EC04 thru EC07 are assigned to format and control the flow of data to and from the Disk Drive Unit.

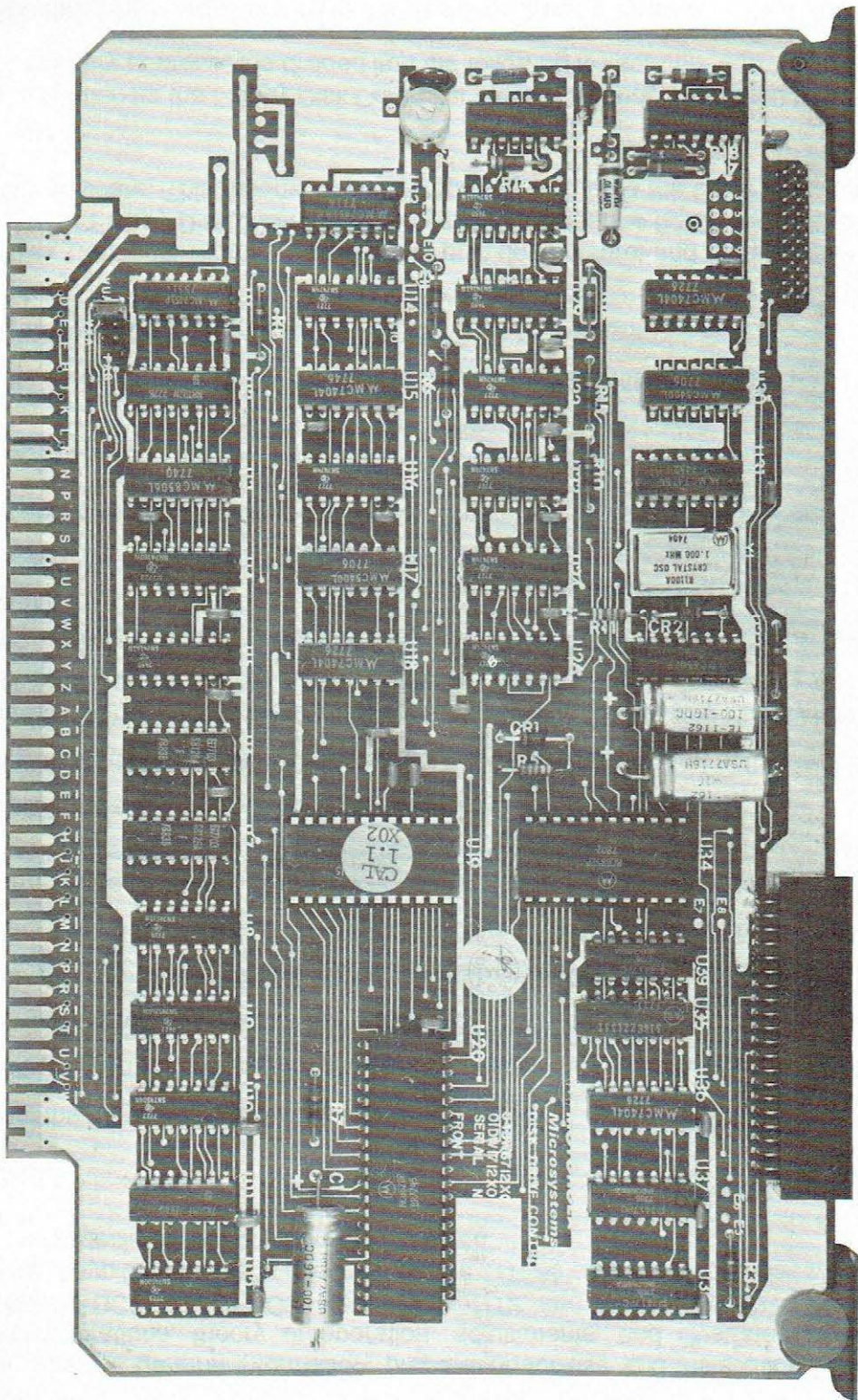


FIGURE 1-1. Typical Floppy Disk Controller Module

The Floppy Disk Controller Module consists of a PIA (Peripheral Interface Adapter) used to control the operation of the Disk Drive Unit, an SSDA (Synchronous Serial Data Adapter) used to format and control the flow of data to and from the Disk Drive Unit, a 1024 x 8-bit ROM (Read Only Memory) containing the Resident Driver Firmware program, a CRC (Cyclic Redundancy Check) code generation circuit, three-state bus interface circuitry, and the necessary address decoding logic to permit accessing from either the EXORciser bus or EXORterm bus.

1.5 EQUIPMENT SUPPLIED

The Floppy Disk Controller Module may be shipped separately or as part of the EXORDisk II/III Floppy Disk System. An Interface Cable is supplied in either case.

TABLE 1-1. Floppy Disk Controller Module Specifications

CHARACTERISTICS	SPECIFICATIONS
Power Requirements	+ 5 Vdc @ 2.75 A + 12 Vdc @ 20 mA - 12 Vdc @ 45 mA (max)
Bus Interface Signals	TTL compatible
Address Bus	
Data Bus	Bi-directional three-state TTL voltage compatible
Control Bus	TTL voltage compatible
EXORDisk II/III Interface Signals	TTL voltage compatible
Operating Temperature	0 to 55°C
Dimensions	
Width x Height	9.75 in. x 6.15 in.
Board Thickness	0.062 in.
Connector Type	
Disk drive Unit Connector (P2) (M68SFDC, M68SFDC2, and M6809FDCONT2)	Standard Applied Engineering 3M 3417-3000 or equivalent
Disk Drive Unit Connector (P2) (M68SFDC3 and M6809FDCONT3)	Amp, Inc. 88393-7 or equivalent

CHAPTER 2 INSTALLATION INSTRUCTIONS AND HARDWARE PREPARATION

2.1 INTRODUCTION

This chapter provides the unpacking, inspection, hardware preparation, and installation instructions for the Floppy Disk Controller Module. This chapter also discusses the module programming considerations.

2.2 UNPACKING INSTRUCTIONS

NOTE

IF THE SHIPPING CARTON IS DAMAGED UPON RECEIPT, REQUEST THAT THE CARRIER'S AGENT BE PRESENT DURING UNPACKING AND INSPECTION OF THE MODULE.

Unpack the Floppy Disk Controller Module from its shipping carton. Refer to the packing list and verify that all of the items are present. Save the packing materials for storing or reshipping of the module.

2.3 INSPECTION

The Floppy Disk Controller Module should be inspected upon receipt for broken, damaged, or missing parts, and for physical damage to the printed circuit board.

2.4 HARDWARE PREPARATION

The M68SFDC2/3 and M6809FDCONT2/3 Floppy Disk Controller Modules have option features which the user may select through jumper installation. The module is shipped with jumpers installed which configure the module to operate in an EXORciser or EXORterm system.

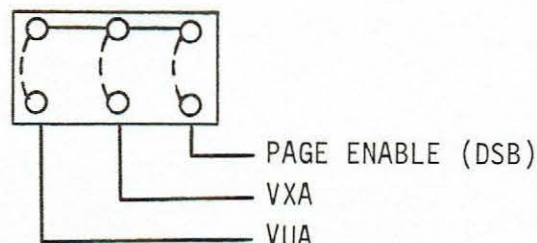
2.4.1 Memory Map Option (M68SFDC2/3 and M6809FDCONT2/3)

The user has the option, through a jumper, of selecting one of the three memory map modes:

- VUA - Valid User Address
- VXA — Valid Executive Address
- PAGE ENABLE — For multiple "pages" of 64K bytes

The module is shipped with VUA selected. Since the Controller operates with MDOS and EXbug, the selection will usually be VUA for Single Map mode, or VXA for Dual Map mode.

A jumper located in the lower left-hand corner of the module is used for the option selection, as shown below:



2.4.2 Clock Speed (M68SFDC2/3 and M6809FDCONT2/3)

The Controller contains a 1.0 MHz time base which allows it to operate with less dependency on system clock. The user may select to operate the controller from the memory clock input on the system bus (if it is 1.0 MHz). At the center left-hand portion are three pads: E9, E10, and E11. To connect to memory clock, the track must be cut between pins E10 and E11. A jumper must be installed between E9 and E10. When used in an M6809 system, especially one with a slow memory, the controller 1.0 MHz time base should be used. Otherwise, unreliable disk operation will result.

2.4.3 Dynamic System Bus (DSB) (M68SFDC2/3 and M6809FDCONT2/3)

Only one meaningful connection is available to the Dynamic System Bus header. PAGE ENABLE is connected to DSB, pin 19, with ground on pin 20. (See para- graph 2.4.1.)

Provisions are made on the module for $\overline{\text{IRQ}}$ input to the DSB. This option, how- ever, would require changes to the ROM firmware, and is reserved for advanced system designs.

2.4.4 Multiple Head/Quad Drive (M68SFDC3 and M6809FDCONT3)

Jumpers are factory installed between E5 and E6 ($\overline{\text{SEL2}}$), E7 and E8 ($\overline{\text{SEL3}}$), and E12 and E13 (D.S.). The connections are provided for EXORdisk III to allow the use of double-sided or single-sided media on the same system, and also to allow the use of up to four drive units.

CAUTION

DO NOT CONNECT AN EXORdisk III FLOPPY DISK CONTROLLER MODULE (M68SFDC3 AND M6809FDCONT3) TO ANY OTHER DRIVE UNITS. SEVERE DAMAGE MAY RESULT.

2.5 INSTALLATION INSTRUCTIONS

The Floppy Disk Controller Module can be used with either the EXORciser or the EXORterm. To install the module, proceed as follows:

- a. Turn power OFF on the equipment in which module is being installed.

CAUTION

INSERTING A FLOPPY DISK CONTROLLER MODULE WHILE POWER IS APPLIED TO THE SYSTEM MAY RESULT IN DAMAGE TO COMPONENTS ON THE MODULE.

- b. Install the module in the selected card slot. (This module may be installed in any of the card slots. However, it is desirable to keep the module as close to the power connector as possible.)
- c. Install the interconnecting cable (observe pin index mark on connector).
- d. Turn power ON.

2.6 PROGRAMMING CONSIDERATIONS

The EXORdisk II/III Floppy Disk Drive Unit is controlled by the Resident Driver Firmware located on the Floppy Disk Controller Module. This firmware program is used to control the two disk drive units and to verify disk operation. However, the data stored on the diskette and the file management of recorded data are controlled by the MDOS software. When the EXORdisk II/III Floppy Disk System is used with the EXORciser or the EXORterm, 16K of contiguous working memory is required for addresses 0000-3FFF. MDOS software is available to the user to control all file management operations. When the EXORdisk II/III Floppy Disk System is incorporated into a user system design, the MDOS software cannot be used. Therefore, those users must write their own Disk Operating System software.

CHAPTER 3 THEORY OF OPERATION

3.1 INTRODUCTION

This chapter provides a block diagram description of the Floppy Disk Controller Module. An overall block diagram of this module is shown in Figure 3-1. Separate block diagrams are presented for both the Read Data Circuit and Write Data Circuit portions of this overall diagram in Figures 3-2 and 3-3, respectively. The schematic diagram for this module is provided in Figure 4-5.

3.2 BLOCK DIAGRAM DESCRIPTION

The Floppy Disk Controller Module occupies 1032 address locations, divided as follows: ROM Resident Driver Firmware addresses E800 to EBFF, PIA addresses EC00 to EC03, and SSDA addresses EC04 to EC07. The address decoding logic decodes these addresses to generate the necessary select signals within the module to read and write data from and to the selected Disk Drive Unit. The module contains the circuits needed to control the reading and writing operations of the Disk Drive Unit, plus the necessary control bus buffers, data bus buffers, and disk drive buffers. The following paragraphs describe the major circuits used to perform these functions.

3.2.1 ROM Resident Driver Firmware (E800 to EBFF)

The Resident Driver Firmware stored in the ROM device is used to control all of the EXORdisk Floppy Disk System hardware operations.

3.2.1.1 Initialization. When the Floppy Disk System is initially accessed by the user, a defined initialization procedure must be used. When the Floppy Disk System is used with the EXORciser, this initialization procedure is automatically performed by the MDOS program when the command E800; G is entered by the user. However, if the Floppy Disk System is used in conjunction with a user-designed system, the user must include this initialization procedure when preparing his own DOS (Disk Operating System) program. Parameters for the initialization procedure are stored in nine sequential bytes, as described in Table 3-1. At this time, the Floppy Disk Controller must determine system speed.

3.2.1.2 Error Messages. The ninth byte (FDSTAT) of the initialization procedure contains a hexadecimal error message (from 30 to 39). If no error occurred during the disk operation, then the carry bit will be reset and the FDSTAT byte will contain the hexadecimal number 30 (ASCII 0): no error. However, if an error does occur, then the carry bit will be set and the FDSTAT byte will contain a hexadecimal number of 31 to 39 (ASCII 1 to 9) that will relate to a specific error message. If an error does occur, any disk operation in progress is halted, and control will be returned to the user. Each of the error messages (and their corresponding hexadecimal and ASCII characters) is explained in Table 3-2.

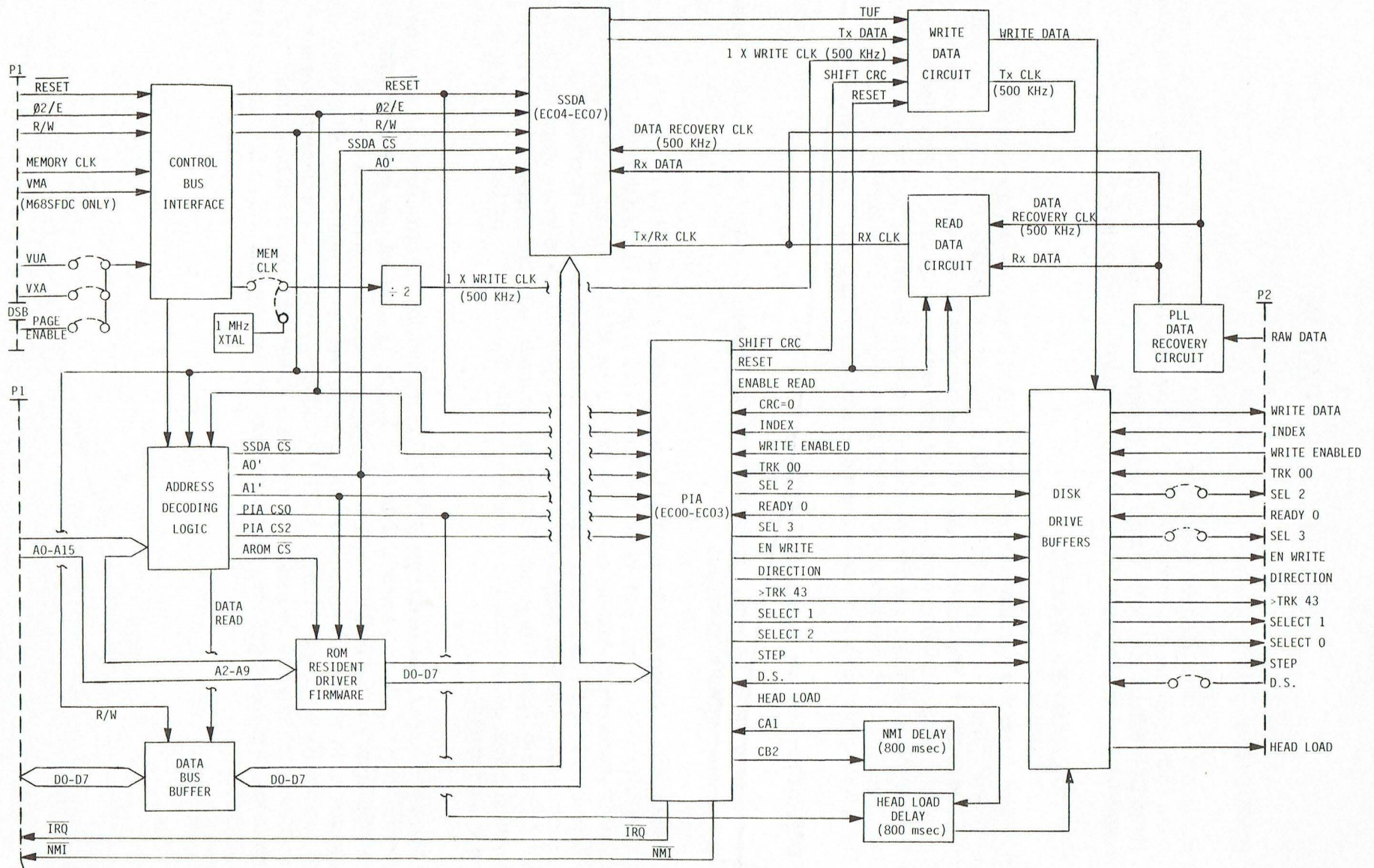


FIGURE 3-1. Floppy Disk Controller Module Block Diagram

TABLE 3-1. Initialization Parameters for a User Prepared DOS Program

BYTE	NAME	DEFINITION
0	CURDRV	CURRENT DRIVE — This byte contains the number of the selected drive unit (0 or 1).
1,2	STRSCT	STARTING SECTOR — These two bytes contain the physical sector number of the first sector to be used (starting sector). For all single-sided, single-density disks, this starting sector number must be between 0 and 2001, inclusively. (4003 for double-sided, single-density disks).
3,4	NUMSCT	NUMBER OF SECTORS — These two bytes contain the number of sectors to be used. This number includes a partial sector read, if one is requested. For all single-density disks, the sum of the numbers contained in the STRSCT parameter and the NUMSCT parameter cannot be greater than 2002 when read or write operations are requested. (4004 for double-sided, single-density disks)
5	LSCTLN	LAST SECTOR LENGTH — During read-into-memory operations, this byte contains the number of bytes to be read from the last sector to be used. This number should be between 1 and 128, since each sector contains 128 bytes. If this number is not between 1 and 128 (inclusive), a CRC error will result when the last sector is read. The Resident Driver Firmware may not stop on the byte specified, since the firmware segments the last sector into 8-byte blocks and stops loading after reading the block containing the last byte requested.
6,7	CURADR	CURRENT ADDRESS — These two bytes contain the first address from/to which data is to be read/written during disk read/write operations. The Resident Driver Firmware automatically updates this entry after each sector is read/written. During write test operations, these two bytes contain the address of a two-byte data buffer.
8	FDSTAT	FLOPPY DISK STATUS — This byte contains a status indication returned from the Resident Driver Firmware ROM. If an error occurred during a disk operation, the carry bit will be set on return to the caller, and this byte will contain a number indicating the type of error. If no error occurs, then carry will be reset and this byte will contain the hexadecimal number 30 (ASCII 0).

TABLE 3-2. Disk Error Messages

FDSTAT (HEX)	ASCII	CARRY BIT	DESCRIPTION/POSSIBLE CAUSE
30	0	Reset	NO ERRORS. This status indication is returned when no errors have occurred in the disk operation. On return to the user, the carry bit is cleared.
31	1	Set	<p>DATA CRC ERROR. This status is returned when the CRC following the data is in error. This error would occur after the sector has been read and, if appropriate, written into memory. The CURADR parameter will not be updated for the sector with the error. In multiple sector operations, the equation listed at the end of this table can be used to determine the sector number of the physical sector in which the error occurred.</p> <p>Possible causes of this error include miswriting and misreading the data and/or CRC. If the error occurred during WRVERF or RWTEST, the sector should be rewritten. Otherwise, another attempt should be made to read the sector. The ROM will attempt to read the sector 5 times before returning this error.</p>
32	2	Set	DISK WRITE PROTECTED. This status is returned whenever an attempt is made to write to a diskette that is protected. In order to write to a protected diskette, a piece of opaque tape must be placed over the write protect hole in the disk's envelope.
33	3	Set	DISK NOT READY. This status is returned when an operation is attempted with a disk that is not ready. Possible causes of the not ready status include the drive unit door not being closed and the diskette not being up to speed.
34	4	Set	READ DELETED DATA MARK. This status is returned when an attempt is made to read a sector that is prefaced by a deleted data mark. The sector will not be read into memory, and the CURADR parameter will not be updated for the sector in error. The equation listed at the end of this table can be used to determine the physical sector number of the sector in error when this error occurs during a multiple sector operation. A possible cause of this error is that a deleted data mark was intentionally written to the sector.
35	5	Set	TIMEOUT. This error occurs whenever a disk operation is not completed before the hardware timer on the interface board times out. This error is also produced if any non-maskable interrupt (such as an ABORT) is generated during a disk operation.

TABLE 3-2. Disk Error Messages (cont'd)

FDSTAT (HEX)	ASCII	CARRY BIT	DESCRIPTION/POSSIBLE CAUSE
36	6	Set	<p>Other possible causes of a disk timeout error include attempting to read or write a bad track or sector or an unformatted disk. Reformatting the disk may eliminate this error. The disk timeout may also occur as a result of the head being positioned at the wrong track.</p> <p>INVALID DISK ADDRESS. This error occurs when the sum of the STRSCT and NUMSCT parameters is greater than the number of sectors on the disk. The RESTOR command does not check for this error.</p>
37	7	Set	<p>SEEK ERROR. This error occurs if a restore is completed incorrectly or track 0 is found before a seek operation is completed. This error may occur during a restore if the drive is <i>not</i> connected to the controller.</p>
38	8	Set	<p>DATA MARK ERROR. This error occurs if a valid data mark for the sector being read has not been found. This error message occurs before the sector is read, and prevents the sector from being read. The CURADR parameter is not updated for the sector in error. The equation provided at the end of this table can be used to determine the number of the physical sector in error, when this error occurs during a multiple sector operation. The Resident Driver Firmware will attempt to read the sector in error 5 times before returning this error message.</p> <p>Possible causes of this error include misreading and miswriting the disk.</p>
39	9	Set	<p>ADDRESS MARK CRC ERROR. This error occurs when the CRC of an address mark is incorrect. This error occurs before the sector is read or written, and stops the operation in progress. The CURADR parameter is not updated for the sector in error. The equation provided at the end of this table can be used to determine the sector number of the physical sector in error, when this error occurs during a multiple sector operation.</p> <p>Possible causes of this error include miswriting the address mark or its CRC when formatting the disk, and misreading the address mark or its CRC. The Resident Driver Firmware will attempt to read the sector in error 5 times before returning this error message.</p>

EQUATION: $PSNE = STRSCT + NUMSCT - SCTCNT - 1$

where: PSNE is the sector number of the physical sector in error.

STRSCT is the contents of the STRSCT parameter.

NUMSCT is the contents of the NUMSCT parameter.

SCTCNT is the 2-byte value contained in locations \$B and \$C. This value is set equal to the contents of the NUMSCT parameter at the beginning of a disk read or write operation, and is then decremented before each sector operation.

3.2.1.3 Resident Driver Firmware Entry Points. Various entry points (addresses) are available to the user to perform specific operations contained within the ROM Resident Driver Firmware. These entry points are provided in Table 3-3, which is divided into three parts: the initialization and error check routines part, the disk operation routines part, and the line printer driver routines part. In these routines, all register contents are unspecified (except where otherwise indicated) on entry to and return.

In addition, the ten entry points in the disk operation routines part are called by a Jump to Subroutine (JSR) and require the indicated parameters. The parameter name is used to represent its contents. Upon entry to a disk routine, the user's interrupt mask is saved and the mask bit is set. The NMI vector is also saved and the Resident Driver Firmware timeout routine entry address is substituted for the NMI vector. (Thus, an ABORT or any other NMI operation during a disk routine will appear as a timeout error.) The FDSTAT byte is then initialized to indicate that no errors occurred. Before returning from a disk routine, the NMI vector and the user's interrupt mask are restored. If an error occurred, the FDSTAT byte will be changed accordingly, and the carry bit will be set.

TABLE 3-3. Resident Driver Firmware Program Entry Points

NAME	LOCATION	FUNCTION
INITIALIZATION AND ERROR CHECK ROUTINES		
OSLOAD	E800	This entry bootloads the disk operating system, initializes the stack pointer and drive electronics, and restores the head position of drive 0 to track 0. The bootloader and the operating system's retrieval information block from sectors 23 ₁₀ and 24 ₁₀ , respectively, of drive 0 are loaded into memory beginning at location 32 ₁₀ . Control is then passed to the bootloader by jumping to that location. If a disk error occurs, the error number is printed at the system console, and control is returned to EXbug. No user parameters need to be specified when the Resident Driver Firmware is entered at this entry point. The firmware will initialize all the required parameters.
FDINIT	E822	This subroutine initializes the PIA and SSDA. No user parameters are required by this subroutine and none are modified by it. This subroutine does not change location FDSTAT or the state of the carry bit.
CHKERR	E853	This subroutine checks for a disk error, if called immediately after return from a disk operation, by checking the carry flag. The subroutine just returns to the user if no error occurred (carry clear). If an error did occur (carry set), then the subroutine prints an E, followed by the contents of FDSTAT (in ASCII) and two spaces at the system console. It then gives control to EXbug. Other than FDSTAT, no user parameters are required. (If a disk error occurred, the Resident Driver Firmware will load the appropriate data into FDSTAT). CHKERR does not modify any user parameters.
PRNTER	E85A	This subroutine prints an E at the system console, followed by the contents of FDSTAT (in ASCII) and two spaces. FDSTAT is the only user parameter required by PRNTER. It does not modify any user parameters.

TABLE 3-3. Resident Driver Firmware Program Entry Points (cont'd)

NAME	LOCATION	FUNCTION
DISK OPERATION ROUTINES		
READSC	E869	This entry causes the NUMSCT parameter number of sectors (beginning with STRSCT of CURDRV) to be read into memory beginning at CURADR. The CURADR parameter is updated to the next address to be written to after each sector is read. This entry point initializes the LSCTLN byte to 128 (decimal) so that all of the last sector read will be written to memory. This routine does not change CURDRV, STRSCT, or NUMSCT.
READPS	E86D	This entry causes the number of sectors (beginning with STRSCT of CURDRV) to be read into memory beginning at CURADR. The CURADR parameter is updated to the next address to be written to after each sector is read. This entry point does not change LSCTLN, so that only a portion of the last sector read may be written to memory. (See LSCTLN under user parameters for a description of last sector segmentation and valid values of LSCTLN.) This routine does not change CURDRV, STRSCT, NUMSCT, or LSCTLN.
RDCRC	E86F	This entry causes NUMSCT sectors beginning with STRSCT of CURDRV to be read to check their CRC's. The sectors are not written to memory. This routine does not change CURDRV, STRSCT, NUMSCT, LSCTLN, or CURADR.
RWTEST	E872	This entry point causes the two bytes of data pointed to by the address in CURADR and address + 1 to be written to alternating bytes, respectively, of NUMSCT sectors beginning with STRSCT of CURDRV. After all of the sectors have been written, they are read back to check their CRC's. This routine does not change CURDRV, STRSCT, NUMSCT, LSCTLN, or CURADR.
RESTOR	E875	This entry point causes the head of CURDRV to be restored to track 0. The head is unloaded from the disk. The drive must be ready or restore will return an error. RESTOR does not verify that STRSCT and NUMSCT are valid. RESTOR is used to position the drive's head at a known track before using the drive. (The OSLOAD routine restores drive 0.) RESTOR does not change CURDRV, STRSCT, NUMSCT, LSCTLN, or CURADR.
SEEK	E878	This entry point causes the head of CURDRV to be positioned at the track containing STRSCT. The head is loaded on the disk. This routine does not change CURDRV, STRSCT, NUMSCT, LSCTLN, or CURADR.
WRTEST	E87B	This entry point causes the two bytes of data pointed to by the address in CURADR and the address + 1 to be written to alternating bytes, respectively, of NUMSCT sectors beginning with STRSCT or CURDRV. This routine does not change CURDRV, STRSCT, NUMSCT, LSCTLN, or CURADR.
WRDDAM	E87E	This entry point causes a deleted data address mark to be written to NUMSCT sectors beginning with STRSCT of CURDRV. This routine does not change CURDRV, STRSCT, NUMSCT, LSCTLN, or CURADR.

TABLE 3-3. Resident Driver Firmware Program Entry Points (cont'd)

NAME	LOCATION	FUNCTION
WRVERF	E881	This entry point causes NUMSCT sectors beginning with STRSCT of CURDRV to be written from memory beginning at CURADR. CURADR is updated to the address of the next byte to be read from after each sector has been written. After all of the sectors have been written, they are read back and their CRC's are verified as in RDCRC. This routine does not change CURDRV, STRSCT, NUMSCT, or LSCTLN.
WRITSC	E884	This entry point causes NUMSCT sectors beginning with STRSCT of CURDRV to be written from memory beginning at CURADR. CURADR is updated to the address of the next byte to be read from after each sector has been written. This routine does not change CURDRV, STRSCT, NUMSCT, or LSCTLN.
CLOCK	E887	This entry point calculates a timing parameter as a function of the system clock frequency for the PROM routines. This is done automatically if the system is started at the OSLOAD entry point. If OSLOAD is not used to bootload the system, then this routine must be called after FDINIT has been called and before any other disk operation is attempted. If CLOCK returns an error, no further disk operations should be attempted. This routine only requires the CURDRV parameter. It does not change CURDRV, STRSCT, NUMSCT, CURADR, or LSCTLN.
LINE PRINTER DRIVER ROUTINES		
LPINIT	EBC0	This subroutine initializes the PIA interfacing with the line printer from a reset condition.
LIST	EBCC	This subroutine sends the contents of the A accumulator to the line printer. If a printer error occurred, carry is set on return to the caller. The LIST routine detects the paper empty and printer not selected conditions as printer errors.
LDATA	EBE4	This subroutine sends a character string pointed to by the index register and terminated by a 04 to the line printer. Prior to the string, it sends a carriage return, then a line feed, to the printer. LDATA uses the LIST subroutine. Thus, any printer errors that occur while using LDATA will be detected by LIST. LDATA will sit in a loop until aborted or the error is corrected.
LDATA1	EBF2	This subroutine performs the same as LDATA except that this subroutine does not print a carriage return and line feed prior to the string. It also uses LIST to send characters to the printer.

3.2.1.4 Disk Mini-Diagnostic Routine (M68SFDC Floppy Disk Controller Only). A Disk Mini-Diagnostic (DMD) routine is also available in the ROM Resident Driver Firmware. This routine permits the user to easily execute any disk function a single time and print the status, or to continuously execute disk functions and keep an error count in RAM. The locations used by the DMD are listed (by name) in Table 3-4. Both single-execution operation and continuous-execution operations are described in the following steps.

- a. **Single Execution Operation.** In order to execute a disk function one time, set up the locations of CURDRV, STRSCT, NUMSCT, LSCTLN, and LDADDR as required for the function. Next, put the entry point address of the function into EXADDR and a non-zero value in ONECON. Then, by typing the MAID command EB98;G, the PIA and SSDA in this module will be initialized, CURDRV will be restored, and the disk function specified by EXADDR will be executed one time on CURDRV. Upon completion of the disk function or detection of an error, the status is printed at the console (the letter E followed by a single digit of 0 to 9), and control is returned to EXbug. Before starting the DMD, the stack pointer should be set to a valid area by using the MAID's register change command. (An EXbug stack pointer value of \$FF8A is acceptable.)

- b. **Continuous Execution Operation.** In order to constantly execute a disk function, set up locations CURDRV, STRSCT, NUMSCT, LSCTLN, and LDADDR as required for the function. Next, put the entry point address of the function into EXADDR and a zero into ONECON. Then, by typing either the MAID command EB98;G (to start DMD at TOP) or EB90;G (to start DMD at CLRTOP, clear the two-byte counters), the PIA and SSDA in this module will be initialized, CURDRV will be restored, and the disk function specified by EXADDR will be continuously executed on CURDRV until one of the two-byte counters is incremented to 0. When a counter reaches 0, an E followed by an indication of the last disk status will be printed at the console, and control will be returned to EXbug. The status printed at the console will not be in the normal range of 0 to 9 but, instead, will be the character that corresponds to twice the ASCII representation of the final status. Once in EXbug, the data in the FDSTAT byte will provide the value of twice the ASCII representation of the final status. For example, if FDSTAT is found to contain a \$60, then the status of the last disk operation was \$30 (ASCII 0, NO ERRORS). In this example, the status 0 counter would have been incremented to 0. The user can also cause DMD to stop on the first error of a given type by initializing the corresponding counter to \$FFFF and entering DMD at TOP.

TABLE 3-4. Disk Mini-Diagnostic Routines

NAME	LOCATION	FUNCTION
CURDRV	0	Same as for normal disk operations.
STRSCT	1	Same as for normal disk operations.
NUMSCT	3	Same as for normal disk operations.
LSCTLN	5	Same as for normal disk operations.
CURADR	6	Set up by DMD from LDADDR before each execution of the requested disk function.

TABLE 3-4. Disk Mini-Diagnostic Routines (cont'd)

NAME	LOCATION	FUNCTION
FDSTAT	8	Same as for normal disk operations.
LDADDR	\$20	These two bytes must be set up by the user with the data he would normally put at CURADR; DMD will update CURADR from LDADDR before each execution of the requested disk function.
EXADDR	\$22	These two bytes contain the address of the entry point of the disk function (READSC, WRVERF, etc.) to be executed by DMD.
ONECON	\$24	This byte contains a flag that indicates if the disk function is to be executed once or continuously. If the byte is zero, the disk function will be executed continuously. If the byte is non-zero, the disk function will be executed once.
	\$60-\$73	This area contains one two-byte counter for each possible status return from 0 through 9. For example, \$60 and \$61 contain a two-byte count of the 0 status returns, \$62 and \$63 contain a two-byte count of the 1 status returns, etc.
CLRTOP	\$EB90	This location is the entry address of DMD and clears the status counters.
TOP	\$EB98	This location is the entry address of DMD without clearing the status counters.

3.2.2 Recording Format

The format of the data recorded on the diskette is a function of the Floppy Disk Controller Module, and is compatible with the IBM 3740 format. In EXORdisk III, this format is expanded to the second side of the diskette if a double-sided diskette is used. Data is recorded on the diskette, using frequency modulation techniques (each data bit recorded on the diskette has an associated clock bit recorded with it). These clock and data bits (if present) are interleaved. By definition, a Bit Cell is the period between the leading edge of one clock bit and the leading edge of the next clock bit. (Thus, the Bit Cell is one clock bit and one data bit if the data bit is present.)

When referring to serial data being written onto or read from the Disk Drive Unit, a byte is defined as eight consecutive Bit Cells. The most significant Bit Cell is defined as Bit Cell 0, and the least significant Bit Cell is defined as Bit Cell 7. During a write operation, Bit Cell 0 of each byte is transferred to the diskette first, with Bit Cell 7 being transferred last. Correspondingly, the most significant byte of data is transferred first, while the least significant byte is transferred last. During read operation, Bit Cell 0 of each byte will be read from the diskette first, with Bit Cell 7 last. As with writing, the most significant byte will also be read from the diskette first.

The EXORdisk II is capable of recording up to 77 tracks of data. The EXORdisk III is capable of recording up to 154 tracks of data. The tracks are numbered 0 to 76. Each track is made available to the recording head by moving the head with a stepper motor and carriage assembly controlled by the PIA located on the Floppy Disk Controller Module. The diskette is rotated by the drive motor at a speed of 360 rpm.

When the MDOS is used, the 77 tracks are formatted in the following manner: the first track (Track 0) contains the disk directory, and the remaining 76 tracks contain data information. Each single-sided disk track is divided into 26 sectors (per side in EXORdisk III) containing 128 bytes each. Preceding each sector is a 6-byte ID Field. This ID Field is formatted as follows:

- Byte 1 — Track #
- Byte 2 — Blank
- Byte 3 — Sector #
- Byte 4 — Blank
- Bytes 5 & 6 — Cyclic Redundancy Check Code

Each field of data recorded on a track is separated from adjacent fields by a number of bytes containing no data bits. These areas are referred to as gaps, and are provided to allow updating of one field without affecting adjacent fields. Four different types of gaps are used: Post-Index Gap, ID Gap, Data Gap, and Pre-Index Gap. The Post-Index Gap is defined as the 32 bytes between Index Address Mark and the ID Address Mark for sector 1 (excluding the address mark bytes). This gap is always 32 bytes in length and is not affected by any updating process. The ID Gap consists of 17 bytes between the ID Field and the Data Field. This gap may vary in size slightly after the Data Field has been updated. The Data Gap consists of 33 bytes between the Data Field and the next ID Field. This gap may also vary slightly after the Data Field has been updated. The Pre-Index Gap is a space of 320 bytes between the last data field on the track and the Index Address Mark. This gap may also vary slightly in length.

Address Marks are unique bit patterns, one byte in length, used to identify the beginning of ID and Data Fields and to synchronize the deserializing circuitry with the first byte of each field. Address Mark bytes are unique from all other data bytes in that certain Bit Cells do not contain a clock bit (all other data bytes have clock bits in every Bit Cell). Four different types of Address Marks are used to identify the different types of fields: Index Address Mark, ID Address Mark, Data Address Mark, and Deleted Data Address Mark. The Index Address Mark is located at the beginning of each track and is a fixed number of bytes in front of the first record. The ID Address Mark is located at the beginning of each ID Field on the diskette. The Data Address Mark is located at the beginning of each non-deleted Data Field on the diskette. The Deleted Data Address Mark is located at the beginning of each deleted Data Field on the diskette.

Each field written on the diskette is appended with two CRC bytes. These two CRC bytes are generated from a cyclic permutation of the data bits, starting with bit zero of the address mark and ending with bit 7 of the last byte within a field (excluding the CRC bytes). When a field is read back from a diskette, the data bits (from bit zero of the address mark to bit 7 of the second CRC byte) are divided by the CRC circuit located on the Floppy Disk Controller Module. A non-zero remainder indicates an error within the data read back from the disk, while a remainder of zero indicates that the data has been read correctly.

3.2.3 Read Operation

The SSDA is used to synchronize read operations by testing the incoming data stream for the first half clock and data pattern of the desired address mark. (The incoming data stream is clocked at 500 kHz — 2 X Read Clock signal.) When a match is found, the external circuitry is released by the Sync Match (SM) output signal, and the second half of the address mark (clock and data) is read by the SSDA and tested for a match with the desired type. If a match does not occur, the sequence is restarted. However, if the second half of the address mark does match, then the desired data transfer is initiated. Circuitry within the Read Data Circuit switches the SSDA read clock (Rx CLK) to 250 kHz after the second half of the address mark has been received, permitting only the data portion of the remaining information (Rx D) to be recovered. This circuitry also controls the CRC code generator timing so that only the data portion of the recovered information is clocked into the generator.

After the data block has been transferred, the CRC status (CRC = 0) is made available to the MPU for 32 microseconds at PIA peripheral line PB7.

The following paragraphs provide an operational description of the circuitry used to read data from the diskette. During this description, refer to the block diagram provided in Figure 3-2 and the schematic diagram provided in Figure 4-5.

3.2.3.1 PLL Data Recovery Circuit. The Phase Locked Loop Data Recovery Circuit consists of a frequency/phase detector circuit with filter network, a voltage-controlled oscillator (VCO), two synchronous 4-bit counters, an 8-bit shift register, and four flip-flops (refer to Figure 4-5). The center frequency of the VCO is nominally 8.0 MHz with a lock range of 7.6 MHz to 8.4 MHz. Lockup time will be less than 192 microseconds.

The Raw Data signal from the Disk Drive Unit is a combination of a 500 kHz clock signal and data. This signal is applied to an input flip-flop circuit consisting of two serially-connected flip-flops. This circuit then generates a negative output pulse width equal to one VCO time period (approximately 0.125 microseconds). This negative pulse is used to preset the first reference counter with a 9, and to set the output of the first data flip-flop to a logic high level.

In the data format used in the disk system (IBM 3740 format), the incoming data stream can have only one consecutive pulse missing. By loading the first reference counter with a 9, it will produce a positive output transition within 15 VCO pulse periods (1.875 microseconds), thus generating a clock edge even if the data pulse is missing. This reference counter will also produce a carryout pulse on the 16th VCO pulse (2 microseconds). This pulse is then compared with the carryout output of the second reference counter by the frequency/phase detector, thus providing a reference for the VCO.

The negative output transitions of the first reference counter are inverted and used to clock the first data flip-flop, causing the output to change to a logic low level. If another data pulse is present in the incoming data stream, then the first data flip-flop is once again set by the input flip-flop circuit. However, if no data is present, then the output of the first data flip-flop will remain at a logic low level until set by a data pulse, which must occur within 32 microseconds of the last data pulse in order to avoid initiating an error message. When the data pulse is set and the first data flip-flop is set, the next output pulse produced by the reference counter causes the second data flip-flop to toggle, producing the NRZ (Non-Return to Zero) data (Rx D) required by the SSDA.

3.2.3.2 CRC Read Error Check Circuit. Separated data and the 500 kHz Data Recovery Clock are applied to the CRC Read Error Circuit from the PLL Data Recovery Circuit. When the second data flip-flop in the PLL Data Recovery Circuit produces the Rx D data signal for the SSDA, the Rx D data signal is also applied to the D input of the 8-bit shift register. This shift register delays the Rx D pulse by 16 microseconds and then applies it to the CRC Read Error Check Circuit.

When the SSDA sync code match occurs, the SSDA outputs a high level SM signal. The first positive edge of the 500 kHz Data Recovery Clock to occur after sync match sets a sync match latch. This enables both a frequency divider ($\div 16$) and the CRC. The frequency divider produces two different output frequencies: 250 kHz ($\div 2$) and 31.25 kHz ($\div 16$). The 250 kHz output is then applied to the CRC.

At the 250 kHz clock rate, only the data bits from the read data are loaded into the CRC. This data, however, is delayed eight bits (four data bits) behind the read data by the 8-bit shift register. This permits the CRC to receive the first half of the address mark which occurs just before the sync match and before the CRC is enabled. The first half of the address is included in the cyclic permutation of data bits which generate the two CRC bytes. Two CRC bytes append every ID and data field.

If the complete address mark and ID or data field has been read correctly, the CRC=0 output will go low after the last CRC byte for that field has been read. The positive transition of the next 31.25 kHz output will reset the CRC=0 output signal to a logic low level, where it will remain until changed to a logic high level by the next low to high transition of the 250 kHz clock pulse. This occurs one byte time after the last byte of the data field. The software test for a CRC error is made during this one byte period. (The CRC=0 output is detected by the software via PB7 of the PIA). If a detectable read error occurs, the CRC=0 will remain high during the one-byte test time.

After completing a CRC check of a single ID or data field, the CRC read error logic is reinitialized before reading the next field by the reset output of the PIA (pin PB0).

3.2.4 Write Operation

The write sequence is described in the following paragraphs. During this description, refer to the block diagram provided in Figure 3-3 and the schematic diagram provided in Figure 4-5. The TUF (Transmitter Underflow) output of the SSDA is used to synchronize write operations by resetting the frequency divider ($\div 16$) while writing the pre-address mark gap from the CRC at a 500 kHz rate provided by the 1 X Write Clock. After counting 11 TUF pulses and 5.5 bytes of pre-address gap, the first half of the desired address mark is stored in the SSDA.

When the first half of the address mark is completed, the TUF output pulse will not be produced by the SSDA. The second half of the address mark may then be loaded, followed by the data to be written on the diskette. The switch clock rate flip-flop is then toggled after the address mark is written, causing the data selector to select a 250 kHz clock signal. This clocks the data portion of the information to be written into the CRC. When the data transfer is completed, two dummy bytes are stored in the SSDA. At the same time, the frame check sequence is appended by the CRC on command of the SHIFT CRC signal from the PIA. A register in the CRC will then be loaded with a postamble (written at the 250 kHz clock rate) after the frame clock sequence has been appended and the first TUF pulse has occurred. On the next TUF pulse, the SSDA clock is switched back to 500 kHz, permitting the data to be written to the diskette.

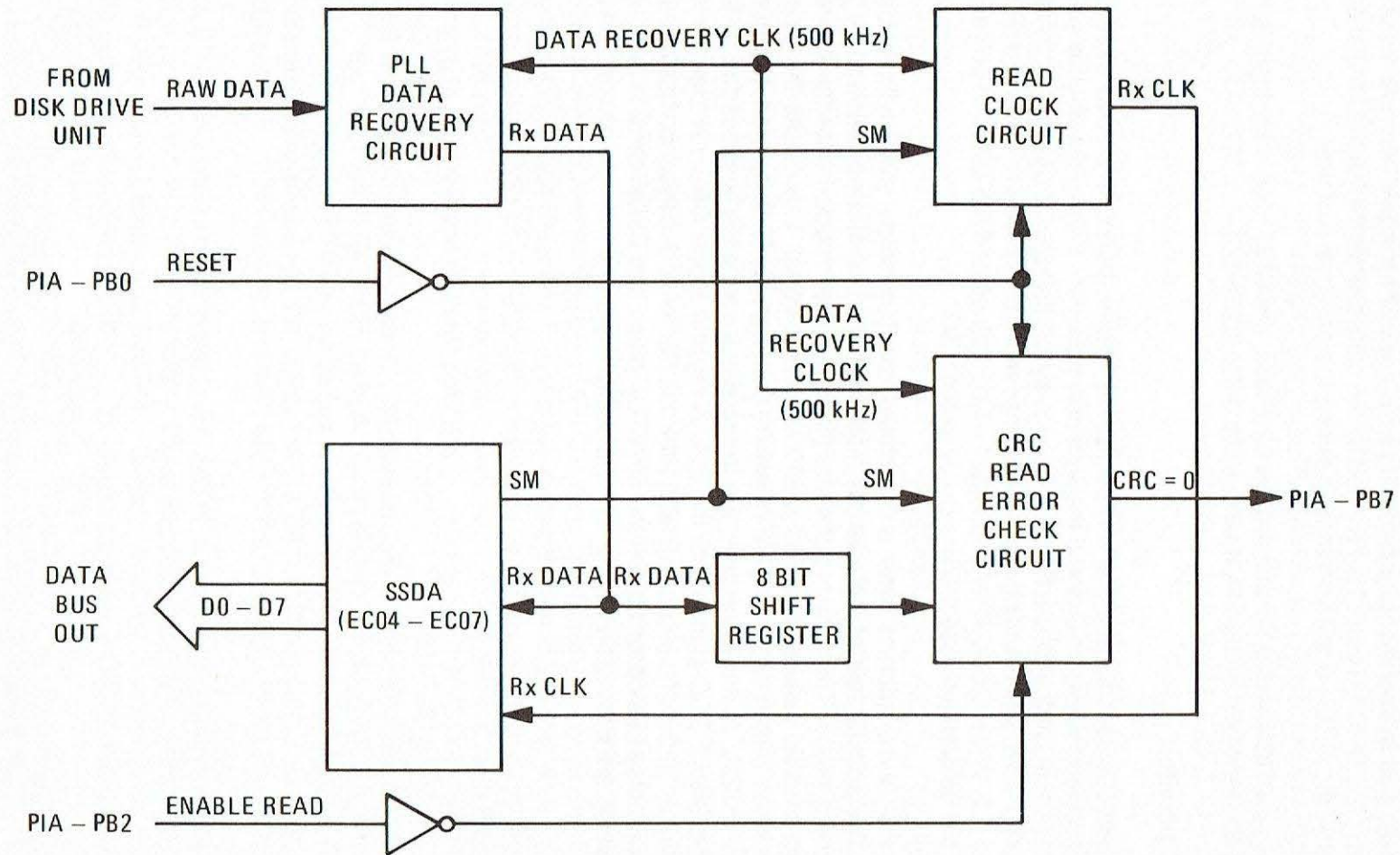


FIGURE 3-2. Read Data Circuit Block Diagram

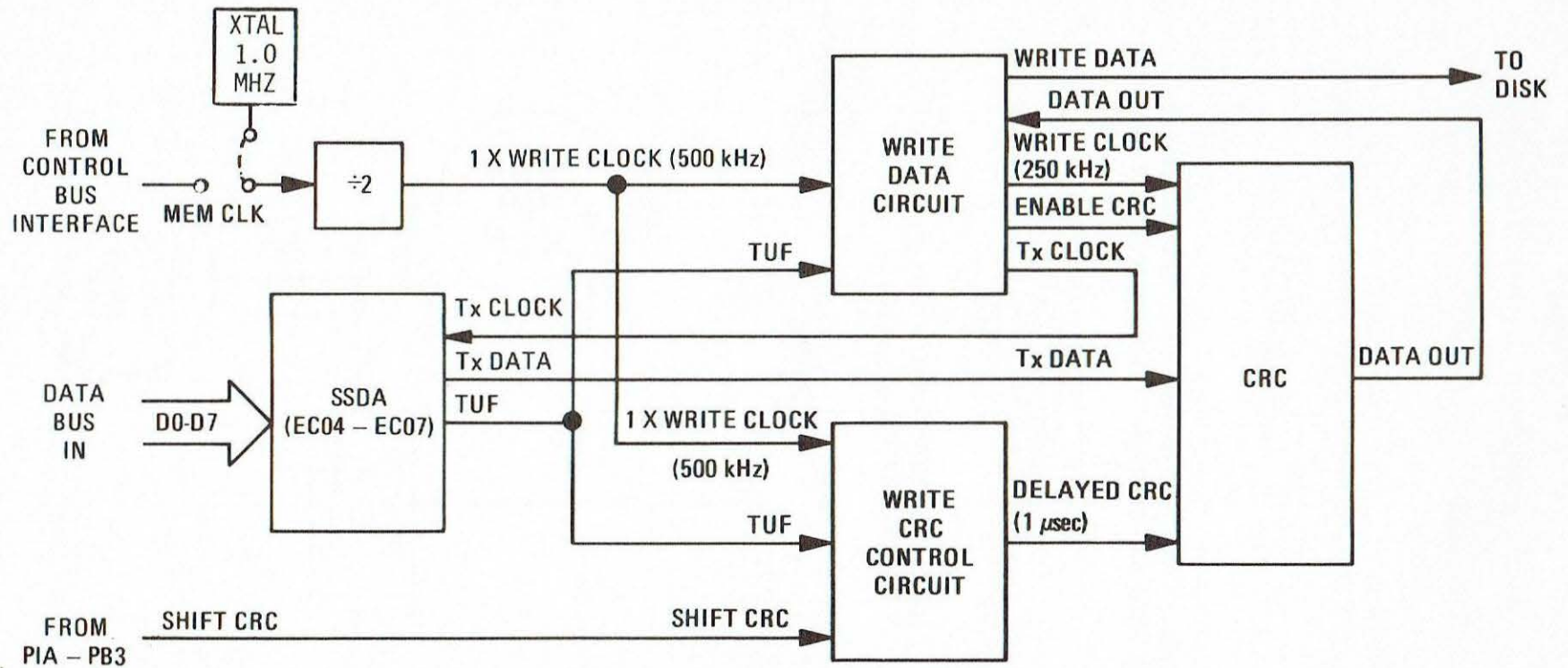


FIGURE 3-3. Write Data Circuit Block Diagram

CHAPTER 4 MAINTENANCE INFORMATION

4.1 INTRODUCTION

This chapter provides the fault isolation, interconnection signals, parts lists with parts location illustrations, and the schematic diagram for the Floppy Disk Controller Module.

4.2 FAULT ISOLATION

Should a fault occur, the information in Figure 4-1 will enable the user to determine if the fault is malfunctioning module, component, disk drive, diskette, or operator error. The user may use Figure 4-1 by starting at a point in the flow chart which best describes the particular problem.

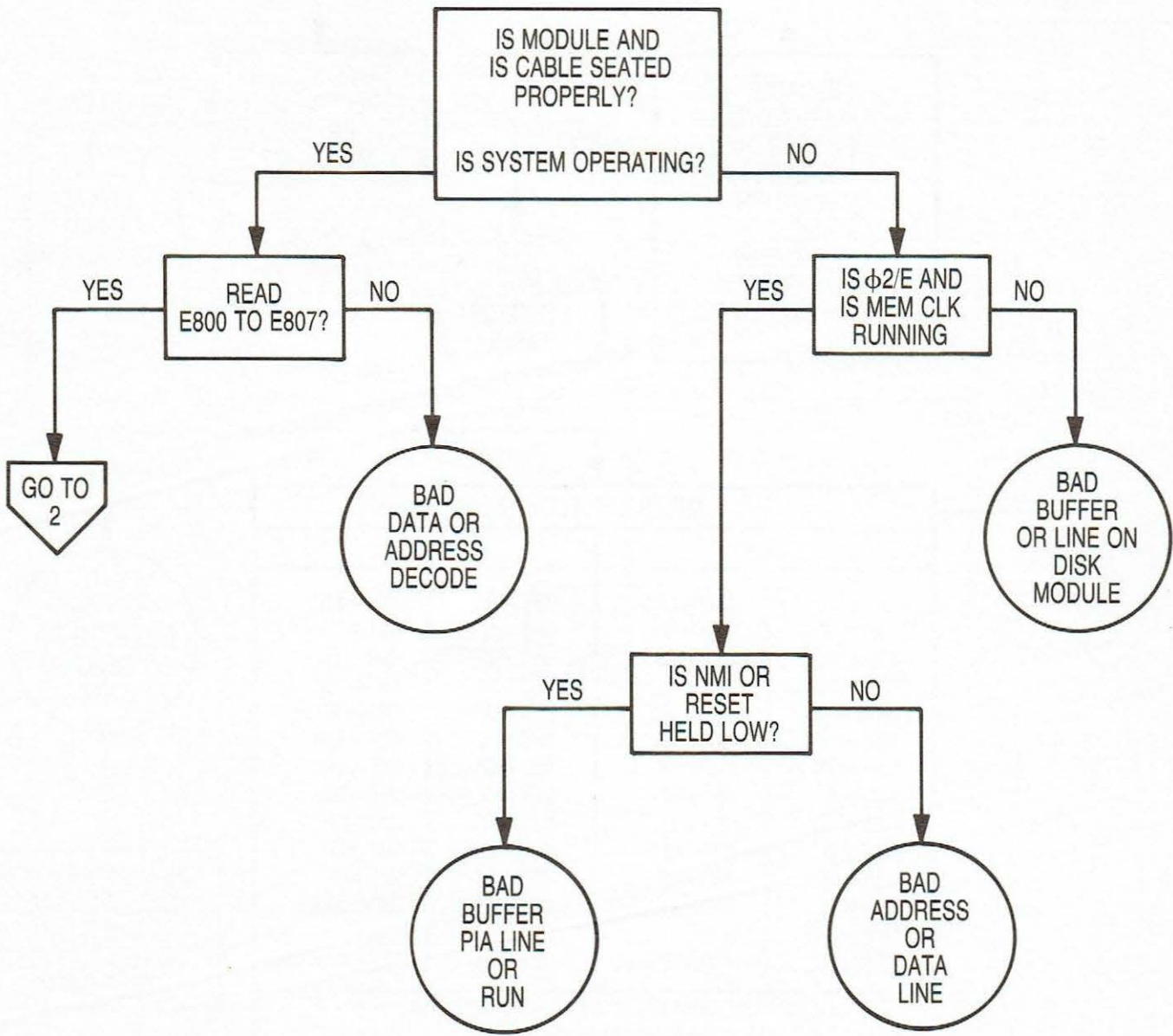


FIGURE 4-1. Fault Isolation

4.3 INTERCONNECT SIGNALS

The Floppy Disk Controller Module is bus compatible with either the EXORciser bus or the EXORterm bus. The bus signals used on this module are identified in Table 4-1, which lists each pin connection, signal mnemonic, and signal characteristic. Table 4-2 identifies the various EXORdisk II/III Floppy Disk System interface signals.

TABLE 4-1. Connector P1 Bus Interface Signals

PIN NUMBER	SIGNAL MNEMONICS	SIGNAL NAME AND DESCRIPTION
A,B,C	+5VDC	+ 5 Vdc Power — Used by the module logic circuits.
D	$\overline{\text{IRQ}}$	INTERRUPT REQUEST — This low level output signal to the MPU requests that an interrupt sequence be initiated. The MPU will wait until it completes the instruction being executed before it recognizes the request. At that time, if the interrupt mask bit in the MPU Condition Code Register is not set, the MPU will begin the interrupt sequence.
E	$\overline{\text{NMI}}$	NON-MASKABLE INTERRUPT — This low-going output signal requests that a non-maskable interrupt be generated within the MPU. The MPU will wait until it completes the instruction being executed before it recognizes the NMI signal. At that time, regardless of the setting of the interrupt mask bit in the MPU, the MPU will begin the interrupt sequence.
F	VMA	VALID MEMORY ADDRESS — This high level input signal from the MPU indicates that a valid memory address is on the address bus, and enables the module to read that address. (M68SFDC Floppy Disk Controller Module only)
H		Not used.
J	$\phi/2/E$	PHASE 2/E — Bi-phase system clock signal.
K		Not used.
L	MEM CLK	MEMORY CLOCK — This signal is an ungated TTL level clock in phase with E, used by the module to generate the Write Clock signal.
M	- 12 VDC	- 12 Vdc Power — Used to generate the - 5 Vdc required by the ROM containing the Resident Driver Firmware. (Not used with 82S2708 ROM device)
N to S		Not used.
T	+ 12 VDC	+ 12 Vdc Power — Used by the ROM containing the Resident Driver Firmware. (Not used with 82S2708 ROM device)
U to Z		Not used.
$\overline{\text{A}}$ to $\overline{\text{F}}$		Not used.
$\overline{\text{H}}$	$\overline{\text{D3}}$	DATA bus (bit 3) — When enabled, this bi-directional line provides a two-way data transfer between this module and the module containing the MPU.
$\overline{\text{J}}$	$\overline{\text{D7}}$	DATA bus (bit 7) — Same as $\overline{\text{D3}}$ on Pin $\overline{\text{H}}$.

TABLE 4-1. Connector P1 Bus Interface Signals (cont'd)

PIN NUMBER	SIGNAL MNEMONICS	SIGNAL NAME AND DESCRIPTION
\bar{K}	$\bar{D}2$	DATA bus (bit 2) — Same as $\bar{D}3$ on Pin \bar{H} .
\bar{L}	$\bar{D}6$	DATA bus (bit 6) — Same as $\bar{D}3$ on Pin \bar{H} .
\bar{M}	A14	ADDRESS bus (bit 14) — One of 16 input address lines used to select a specific disk operation.
\bar{N}	A13	ADDRESS bus (bit 13) — Same as A14 on Pin \bar{M} .
\bar{P}	A10	ADDRESS bus (bit 10) — Same as A14 on Pin \bar{M} .
\bar{R}	A9	ADDRESS bus (bit 9) — Same as A14 on Pin \bar{M} .
\bar{S}	A6	ADDRESS bus (bit 6) — Same as A14 on Pin \bar{M} .
\bar{T}	A5	ADDRESS bus (bit 5) — Same as A14 on Pin \bar{M} .
\bar{U}	A2	ADDRESS bus (bit 2) — Same as A14 on Pin \bar{M} .
\bar{V}	A1	ADDRESS bus (bit 1) — Same as A14 on Pin \bar{M} .
$\bar{W}, \bar{X}, \bar{Y}$	GND	GROUND
1,2,3	+5 VDC	+5 Vdc Power — Used by the module logic circuits.
4		Not used.
5	RESET	RESET — This buffered input signal permits the module to be restarted by either an external switch closure to ground or by the low level RESET signal from the module containing the MPU.
6	R/W	READ/WRITE — This signal controls whether data is to be read (high) from the module or written (low) into the module. The normal standby state of the signal is read (high). This signal will also be in the read state whenever the MPU is halted.
7 to 9		Not used.
10	VUA	VALID USER ADDRESS — This signal, jumper selectable, is produced by the DEbug Module. When high, this signal indicates that the address on the address bus is valid and the MPU is <u>NOT</u> addressing the EXbug program. (M68SFDC2/3 and M6809FDCONT2/3 Floppy Disk Controller Module only)
11	-12 VDC	-12 Vdc Power — Used to generate the -5 Vdc required by the ROM containing the Resident Driver Firmware. (Same as Pin M)
12-15		Not used.
16	+12 VDC	+12 Vdc Power — Used by the ROM containing the Resident Driver Firmware. (Same as Pin T)
17,18		Not used.
19	VXA	VALID EXECUTIVE ADDRESS — A high level signal, jumper selectable, generated by the DEbug Module in place of the VUA signal when the system is operating in the Dual Map mode and the EXbug program is addressing the Executive portion of the memory map. (M68SFDC2/3 and M6809FDCONT2/3 Floppy Disk Controller Module only)
20-28		Not used.

TABLE 4-1. Connector P1 Bus Interface Signals (cont'd)

PIN NUMBER	SIGNAL MNEMONICS	SIGNAL NAME AND DESCRIPTION
29	$\overline{D1}$	DATA bus (bit 1) — Same as $\overline{D3}$ on Pin \overline{H} .
30	$\overline{D5}$	DATA bus (bit 5) — Same as $\overline{D3}$ on Pin \overline{H} .
31	$\overline{D0}$	DATA bus (bit 0) — Same as $\overline{D3}$ on Pin \overline{H} .
32	$\overline{D4}$	DATA bus (bit 4) — Same as $\overline{D3}$ on Pin \overline{H} .
33	A15	ADDRESS bus (bit 15) — Same as A14 on Pin \overline{M} .
34	A12	ADDRESS bus (bit 12) — Same as A14 on Pin \overline{M} .
35	A11	ADDRESS bus (bit 11) — Same as A14 on Pin \overline{M} .
36	A8	ADDRESS bus (bit 8) — Same as A14 on Pin \overline{M} .
37	A7	ADDRESS bus (bit 7) — Same as A14 on Pin \overline{M} .
38	A4	ADDRESS bus (bit 4) — Same as A14 on Pin \overline{M} .
39	A3	ADDRESS bus (bit 3) — Same as A14 on Pin \overline{M} .
40	A0	ADDRESS bus (bit 0) — Same as A14 on Pin \overline{M} .
41,42,43	GND	GROUND

TABLE 4-2. Connector P2 Interconnection Signals

PIN NUMBER	SIGNAL MNEMONICS	SIGNAL NAME AND DESCRIPTION
1	+5 Vdc	+5 Vdc Power — Output voltage supplied to Disk Drive Unit for logic circuits.
2		Not used.
3	+5 Vdc	+5 Vdc Power — Output voltage supplied to Disk drive Unit for logic circuits.
5	$\overline{\text{DIRECTION}}$	DIRECTION — This signal output is used in conjunction with the STEP signal to move the recording head from track to track. When this signal is a logic low level, the recording head is moved to the lower numbered tracks (out). When this signal is a logic high level, the head moves to the higher numbered tracks (in). This signal must remain in the desired logic state during the duration of the STEP signal.
7	$\overline{\text{STEP}}$	STEP — This signal output is used in conjunction with the DIRECTION signal to move the recording head from track to track. A logic low level pulse causes the head to be moved one track (step) in the direction indicated by the DIRECTION signal.
9	D.S.	DOUBLE-SIDED INDICATION — Used only on EXORDisk III (damage may result if connected to other systems).
11,13		Not used.
15	$\overline{\text{SELECT 0}}$	SELECT 0 — The logic low level output signal used to select disk drive 0.

TABLE 4-2. Connector P2 Interconnection Signals (cont'd)

PIN NUMBER	SIGNAL MNEMONICS	SIGNAL NAME AND DESCRIPTION
17	$\overline{\text{TRK 00}}$	TRACK 00 — Low level input signal used to indicate when the recording head is positioned over track 00. When low, the stepper motor drive circuits are inhibited to prevent further outward movement of the head.
19	$\overline{\text{HEAD LOAD}}$	HEAD LOAD — This low level output signal is used to position the flexible diskette against the recording head.
21	$\overline{\text{READY 0}}$	READY 0 — This low level input signal is used to indicate that the flexible diskette is inserted correctly into disk drive 0, and that the dc voltage levels and disk speed in this drive are correct.
23	$<\overline{\text{TRK 43}}$	ABOVE TRACK 43 — This output signal is used to control the amplitude of the write current in the recording head. When recording on tracks 0 thru 43, this signal must be a high level. Conversely, when recording on tracks 44 thru 76, this signal must be a low level.
25	$\overline{\text{INDEX}}$	INDEX — A low level input pulse used to indicate the beginning of a track. This pulse occurs once per revolution of the diskette.
27	$\overline{\text{HEAD 1}}$	HEAD 1 — An EXORdisk III signal, jumper selectable, in advanced design systems to select the drive head. (M68SFDC3 Floppy Disk Controller Module only)
29	$\overline{\text{WRITE ENABLED}}$	WRITE ENABLED — A low level input signal used to indicate that writing may take place.
31	$\overline{\text{WRITE DATA}}$	WRITE DATA — This output signal consists of low level pulses representing data to be recorded on the flexible diskette. Write current reverses direction on the leading edge of each pulse.
33	$\overline{\text{EN WRITE}}$	ENABLE WRITE — A low level output signal used to enable recording of data on the flexible diskette. When this signal is a high level, reading data from the flexible disk is enabled.
35	$\overline{\text{READY 1}}$	READY 1 — This low level input signal is used to indicate that the flexible diskette is inserted correctly into disk drive 1, and that the dc voltage levels and disk speed in this drive are correct. (M68SFDC Floppy Disk Controller Module only)
35	$\overline{\text{SEL 2/3}}$	SELECT 2 or 3 — An EXORdisk III signal, jumper selectable, used in advanced design systems to select Drive 2 or 3. (M68SFDC3 Floppy Disk Controller Module only)
37	$\overline{\text{RAW DATA}}$	RAW DATA — This input signal contains the unseparated data read from the flexible diskette.
39	$\overline{\text{SELECT 1}}$	SELECT 1 — A low output signal used to select disk drive 1.
2-40	GND	GROUND (all even numbered pins are GROUND)

4.4 PARTS LIST

Tables 4-3 through 4-5 list the components of the Floppy Disk Controller Module and Interconnecting Cable Assemblies. The part locations for the Floppy Disk Controller Modules are illustrated in Figures 4-2 through 4-4. Each of these parts lists reflects the latest issue of the hardware at the time of printing.

The EXORdisk II Disk Drive Unit is available with drive units manufactured by two different original equipment manufacturers. Therefore, a minor difference (Resident Driver Firmware) exists between controller modules used with each type. These differences are indicated in the parts list for the module. The EXORdisk-to-EXORciser Interconnecting Cable Assembly is required only when the Calcomp version of the Disk Drive Unit is used. In the Pertec drive version, the interconnecting cable is part of the Disk Drive Unit chassis. Therefore, the Calcomp drive interconnecting cable assembly is listed in this chapter, while the Pertec drive interconnecting cable assembly is listed in its associated disk drive maintenance manual.

TABLE 4-3. M68SFDC Floppy Disk Controller Module Parts List (Calcomp Issues K thru M and Pertec Issues K thru R)

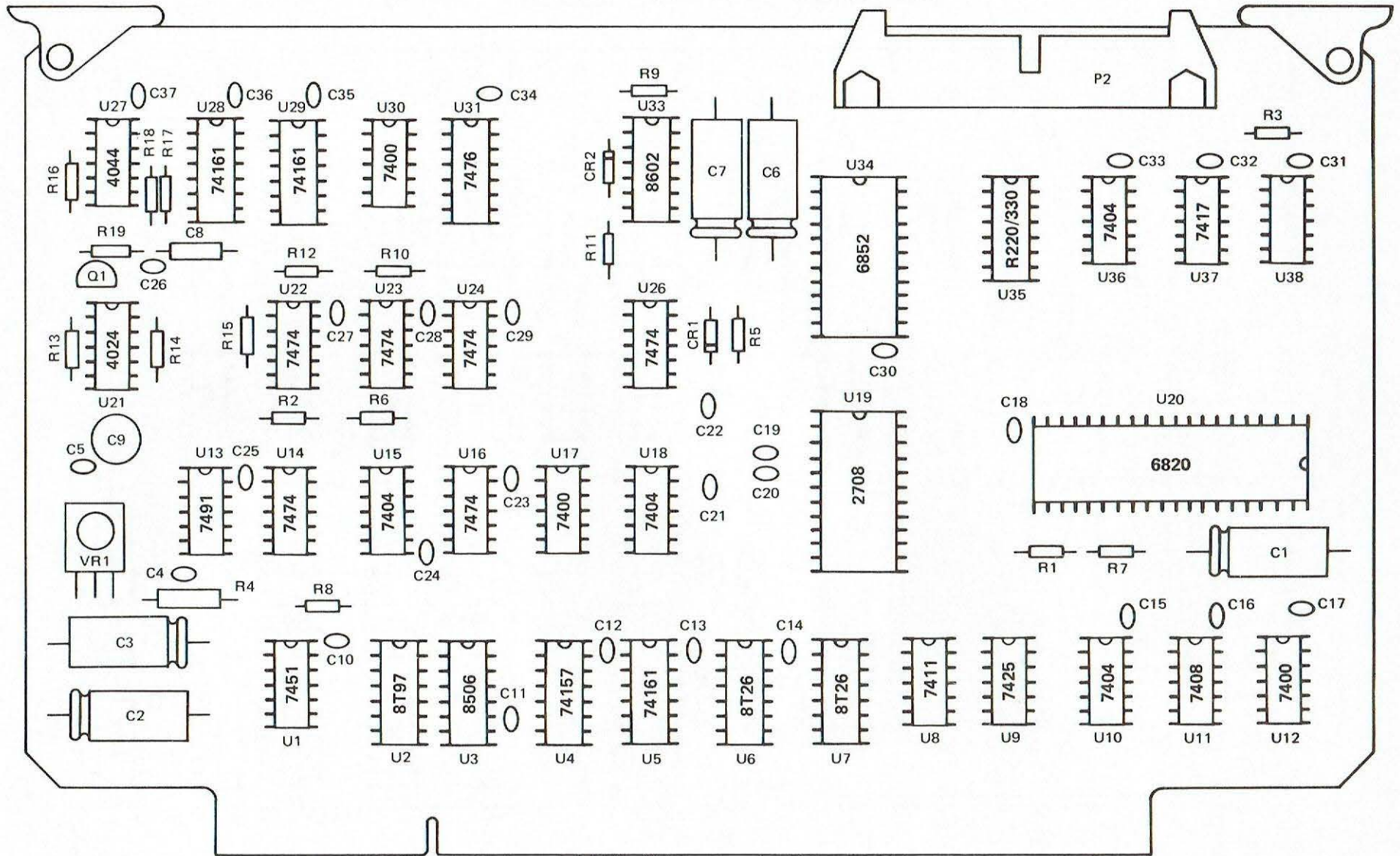
REFERENCE DESIGNATOR	MOTOROLA PART NUMBER	DESCRIPTION	PERTEC EFFEC-TIVITY	CALCOMP EFFEC-TIVITY
	84EW6221X01	Printed Circuit Board, Floppy Disk Controller	K	K
	55NW9403A05	Ejector, Circuit Card with Roll Pin Attachment (2 required)	K	K
C1,C6,C7	23NW9618A09	Capacitor, Electrolytic, 100 μ F @ 16 Vdc	P	L
C2,3	23NW9618A09	Capacitor, Electrolytic, 100 μ F @ 16 Vdc (Deleted)	P	L
C4,5	21NW9604A18	Capacitor, Ceramic, 0.68 μ F @ 50 Vdc (Deleted)	P	L
C8	08NW9621A03	Capacitor, Poly Film, 0.1 μ F @ 100 Vdc	K	K
C9	20NW9628Z02	Capacitor, Ceramic Trim, 8 to 25 pF @ 350 Vdc	K	K
C10-C37	21NW9702A09	Capacitor, Ceramic, 0.1 μ F @ 50 Vdc	K	K
C38	21NW9605A20	Capacitor, Fixed Mica, 10 pF @ 500 Vdc	K	K
CR1,CR2	48NW9607A01	Diode, 1N4001		
P2	28NW9802A33	Connector, Right Angle Solder Tail, 40-pin	K	K
Q1	48NW9610A21	Transistor, MPS6571	K	K
R1,R2 R6-R10,R12 R15,R16	06SW-124A49	Resistor, Fixed Carbon, 1K ohm, 5%, 1/4 W	K	K

TABLE 4-3. M68SFDC Floppy Disk Controller Module Parts List (cont'd)
(Calcomp Issues K thru M and Pertec Issues K thru R)

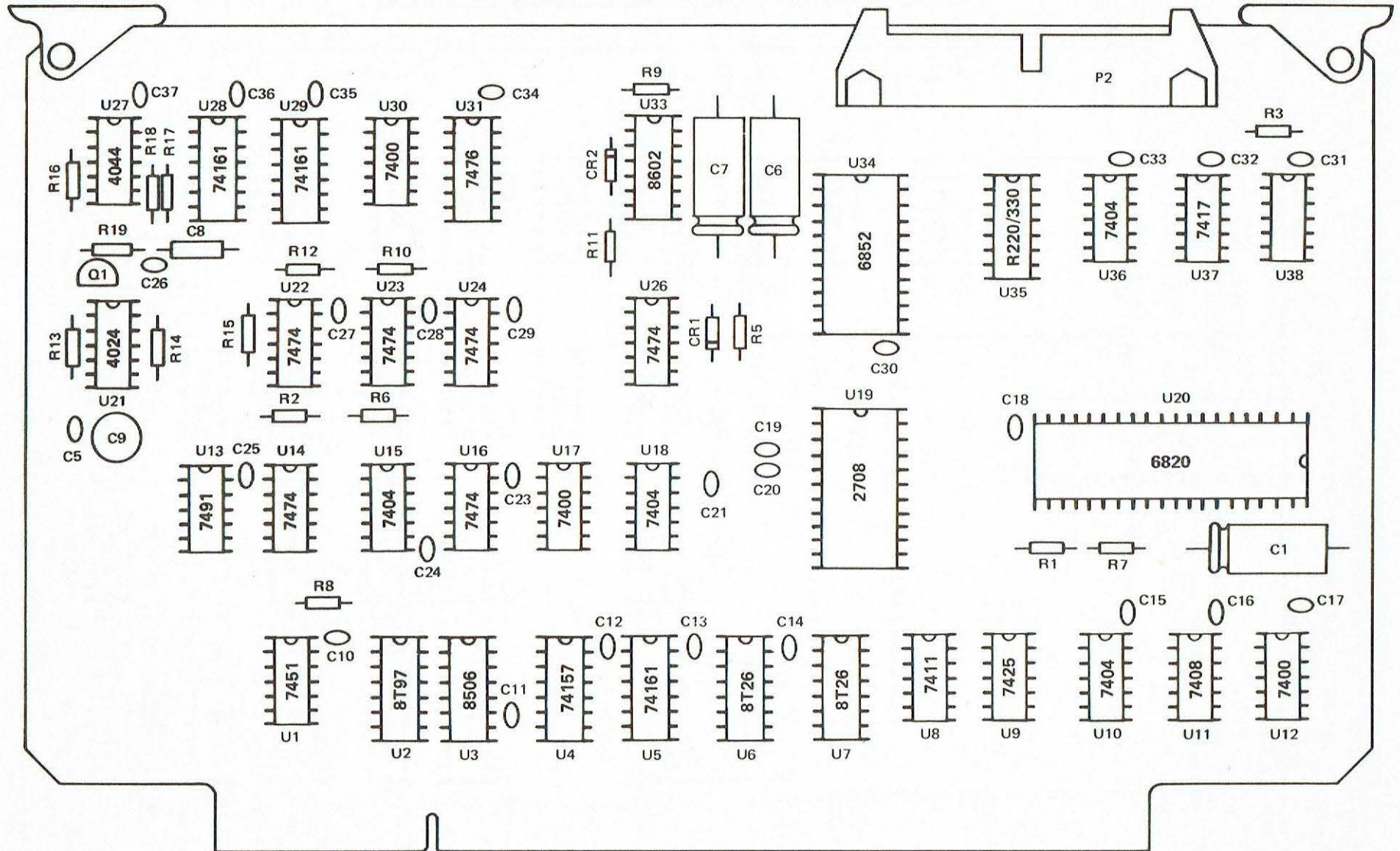
REFERENCE DESIGNATOR	MOTOROLA PART NUMBER	DESCRIPTION	PERTEC EFFEC-TIVITY	CALCOMP EFFEC-TIVITY
R3	06SW-124A65	Resistor, Fixed Carbon, 4.7K ohm, 5%, 1/4W	K	K
R4	06SW-125A11	Resistor, Fixed Carbon, 27 ohm, 5%, 1/2 W (Deleted)	P	L
R5,R11	06SW-124A83	Resistor, Fixed Carbon, 27K ohm, 5%, 1/4 W	L	K
R13	06NW9602A23	Resistor, Fixed Film, 464 ohm, 1%, 1/8 W	K	K
R14	06SW-124A53	Resistor, Fixed Carbon, 1.5K ohm, 5%, 1/4 W	K	K
R17,R18	06SW-124A57	Resistor, Fixed Carbon, 2.2K ohm, 5%, 1/4 W	K	K
R19	06SW-124A55	Resistor, Fixed Carbon, 1.8K ohm, 5%, 1/4 W	K	K
U1	51NW9615A44	I.C., SN7451N	K	K
U2	51NW9615B71	I.C., 8T97	K	K
U2	51NW9615D23	I.C., 8T95 Alternate Device	R	M
U3	51NW9615C79	I.C., MC8506L	K	K
U4	51NW9615A78	I.C., SN74157N	K	K
U5,U28,U29	51NW9615B17	I.C., SN74161N	K	K
U6,U7	51NW9615B35	I.C., 8T26	K	K
U8	51NW9615C54	I.C., N7411A	K	K
U9	51NW9615C76	I.C., MC7425P	K	K
U10,U15, U18,U36	51NW9615A35	I.C., MC7404P	K	K
U11	51NW9615A37	I.C., MC7408P	K	K
U12,U17,U30	51NW9615A32	I.C., MC7400P	K	K
U13	51NW9615C78	I.C., MC7491A	K	
U14,U16, U22-U24,U26	51NW9615A47	I.C., SN7474N	K	K
U19	51AW1369X01	I.C., Programmed CAL 1.1		K
(Calcomp Drives Only)	51AW1368X01	I.C., Alternate Device		

TABLE 4-3. M68SFDC Floppy Disk Controller Module Parts List (cont'd)
(Calcomp Issues K thru M and Pertec Issues K thru R)

REFERENCE DESIGNATOR	MOTOROLA PART NUMBER	DESCRIPTION	PERTEC EFFEC-TIVITY	CALCOMP EFFEC-TIVITY
U19	51AW1369X02	I.C., Programmed PER 0.5	N	
(Pertec Drives Only)	51AW1368X02	I.C., Alternate Device		
U19	51NW9615C73	I.C., C2708 (Deleted)	P	L
U20	51NW9615B27	I.C., MC6820L	K	K
U21	51NW9615A28	I.C., MC4024P	K	K
U27	51NW9615B31	I.C., MC4044P	K	K
U31	51NW9615C77	I.C., MC7476P	K	K
U33	51NW9615B39	I.C., MC8602P	K	K
U34	51NW9615C74	I.C., MC6852P	K	K
U35	51NW9626A20	Resistor Network, 220/330 ohm, 16 pin		
U37,U38	51NW9615C75	I.C., SN7417N	K	K
VR1	51NW9615C39	I.C., MC7905 (Deleted)	P	L
	28NW9802B08	Socket, DIL, 24 pin (2 required)	M	K



**FIGURE 4-2. M68SFDC Floppy Disk Controller Module
(Calcomp Version K and Pertec Version N), Parts Location**



**FIGURE 4-3. M68SFDC Floppy Disk Controller Module
(Calcomp Version L and Pertec Version P) Parts Location**

**TABLE 4-4. M68SFDC2/3 and M6809FDCONT2/3 Floppy Disk Controller Module
Parts List**

REFERENCE DESIGNATOR	MOTOROLA PART NUMBER	DESCRIPTION	EFFECTIVITY
	84DW6712X01	Printed circuit Board, Floppy Disk Controller	M
	55NW9403A10	Ejector, M6800 Circuit Card with Roll Pin Attachment (2 required)	M
	55NW9403A12	Ejector, M6809 Circuit Card with Roll Pin Attachment (2 required)	H
C1	23NW9618A33	Capacitor, Electrolytic, 25 μ F @ 16 Vdc	M
C6,C7	23NW9618A09	Capacitor, Electrolytic, 100 μ F @ 16 Vdc	M
C8	08NW9621A03	Capacitor, Poly Film, 0.1 μ F @ 100 Vdc	M
C9	20NW9628A02	Capacitor, Ceramic Trim, 8 to 25 pF @ 350 Vdc	M
C10-C37	21NW9702A09	Capacitor, Ceramic, 0.1 μ F @ 50 Vdc	M
C38	21NW9629A02	Capacitor, Fixed Mica, 10 pF @ 500 Vdc	M
C39	21NW9629A18	Capacitor, Fixed Mica, 56 pF @ 100 Vdc	M
CR1,CR2	48NW9607A01	Diode, 1N4001	M
P2	28NW9802C35	Connector, Right Angle Solder Tail, 40 pin	M
Q1	48NW9610A21	Transistor, MPS6571	M
R2,R6-R10, R12,R15,R16	06SW-124A49	Resistor, Fixed Carbon, 1K ohm, 5%, 1/4 W	M
R3	06SW-124A45	Resistor, Fixed Carbon, 680 ohm, 5%,1/4 W	M
R5,R11	06SW-124A83	Resistor, Fixed Carbon, 27K ohm, 5%, 1/4 W	M
R13	06NW9602A23	Resistor, Fixed Film, 464 ohm, 1%, 1/8 W	M
R14	06SW-124A53	Resistor,Fixed Carbon, 1.5K ohm, 5%, 1/4 W	M
R17,R18	06SW-124A57	Resistor, Fixed Carbon, 2.2K ohm, 5%, 1/4 W	M
R19	06SW-124A55	Resistor,Fixed Carbon, 1.8K ohm, 5%, 1/4 W	M
U1	51NW9615A44	I.C., SN7451N	M
U2	51NW9615B71	I.C., 8T97 (Alternate Device 8T95)	M
U3	51NW9615C79	I.C., MC8506L	M
U4	51NW9615A78	I.C., SN74157N	M
U5,U28,U29	51NW9615B17	I.C., SN74161N (Alternate Device MC8316P)	M
U6,U7	51NW9615F19	I.C., 8T26A	M
U8	51NW9615D90	I.C., SN74S11N	M
U9	51NW9615E67	I.C., SN74S260N	M
U10	51NW9615C96	I.C., SN74S04N	M
U11	51NW9615C56	I.C., SN74S08N	M
U12	51NW9615C94	I.C., SN74S00N	M
U13	51NW9615C78	I.C., MC7491A	M

**TABLE 4-4. M68SFDC2/3 and M6809FDCONT2/3 Floppy Disk Controller Module
Parts List (cont'd)**

REFERENCE DESIGNATOR	MOTOROLA PART NUMBER	DESCRIPTION	EFFEC-TIVITY
U14,U16, U22-U24,U26	51NW9615A47	I.C., SN7474N	M
U15,U18, U36,U40	51NW9615A35	I.C., MC7404P	M
U17,U30	51NW9615A32	I.C., MC7400P	M
U19	51AW1630X10	I.C., Programmed, EXORdisk II (M6800)	M
U19	51AW1630X09	I.C., Programmed, EXORdisk III (M6800)	M
U19	51AW1369X14	I.C., Programmed, EXORdisk II (M6809)	H
U19	51AW1369X13	I.C., Programmed, EXORdisk III (M6809)	H
U19	51NW9615D15	I.C., 82S2708	M
U19	51AW1630X13	I.C., Alternate, Programmed, EXORdisk II (M6809)	H
U19	51AW1639X12	I.C., Alternate, Programmed, EXORdisk III (M6809)	H
U19	51NW9615F17	I.C., 82S181	H
U20	51NW9615D85	I.C., MC68B21P	M
U21	51NW9615A28	I.C., MC4024P	M
U27	51NW9615B31	I.C., MC4044P	M
U31	51NW9615C77	I.C., MC7476P	M
U33	51NW9615B39	I.C., MC8602P	M
U34	51NW9615F20	I.C., MC68B52P	M
U35	51NW9626A20	Resistor Network, 220/330 ohm, 16 pin	M
U37,U38,U39	51NW9615C75	I.C., SN7417N	M
Y1	48NW9606A04	Crystal Oscillator, 1 MHz, K1100A	M
	28NW9802C12	Header, Double Row Post, 20 Pin	M
	28NW9802B21	Header, Double Row Post, 6 Pin	M
	29NW9805A91	Jumper, 2-positon	M
	28NW9802B07	Socket, DIL-16 pin (use at U28,U29)	M
	28NW9802B08	Socket, DIL, 24 pin (2 required)	M

**TABLE 4-5. M68SFDC EXORdisk II to EXORciser
Interconnecting Cable Assembly Parts List**

REFERENCE DESIGNATOR	MOTOROLA PART NUMBER	DESCRIPTON	EFFEC-TIVITY
	28NW9802A38	Connector, 40 Pin PCB	M
	30NW9302A20	Cable, Flat 40 Conductor-65'', 28 AWG, Stranded	M
	43NW9002A53	Insert, Key Polarizing	M

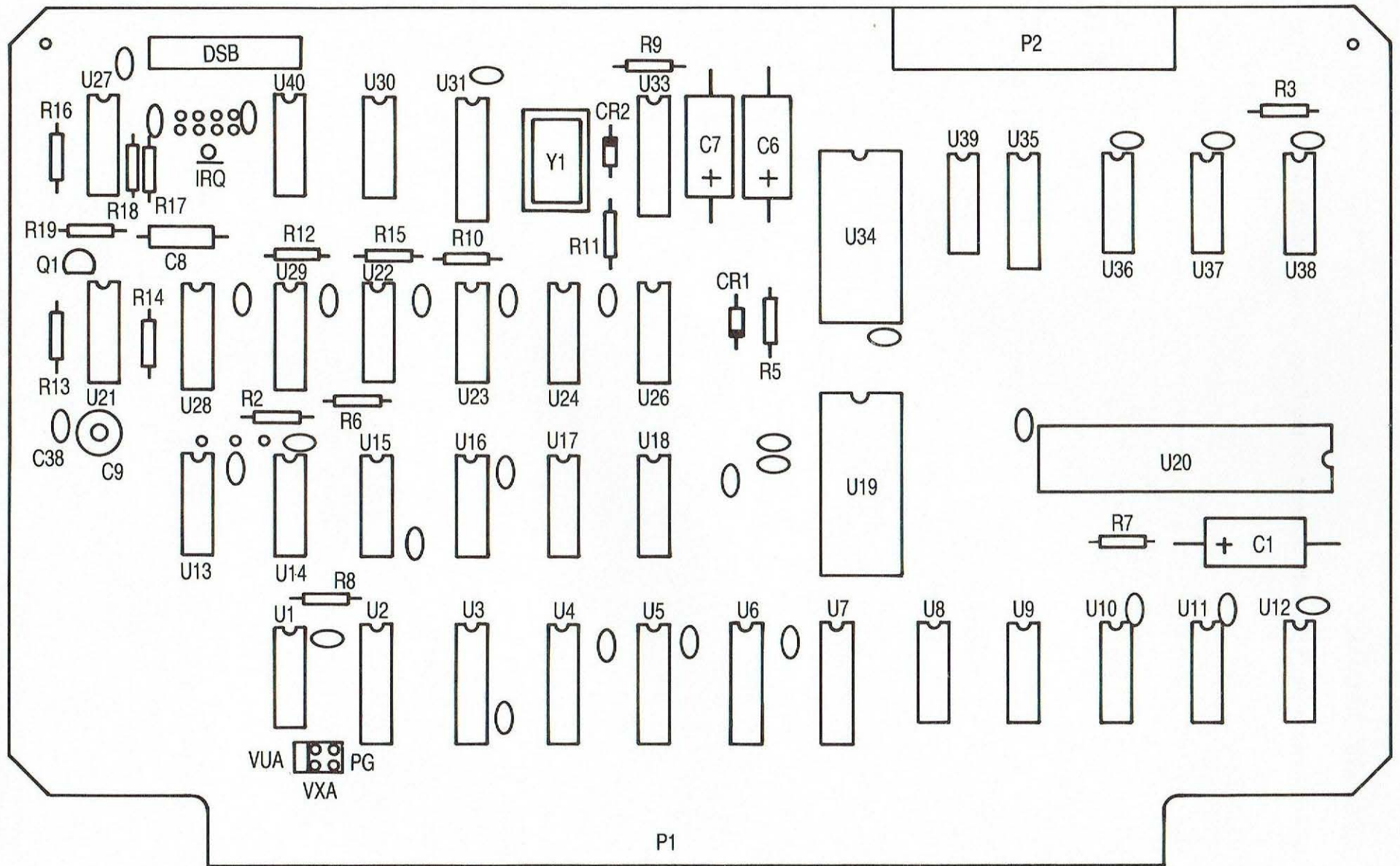
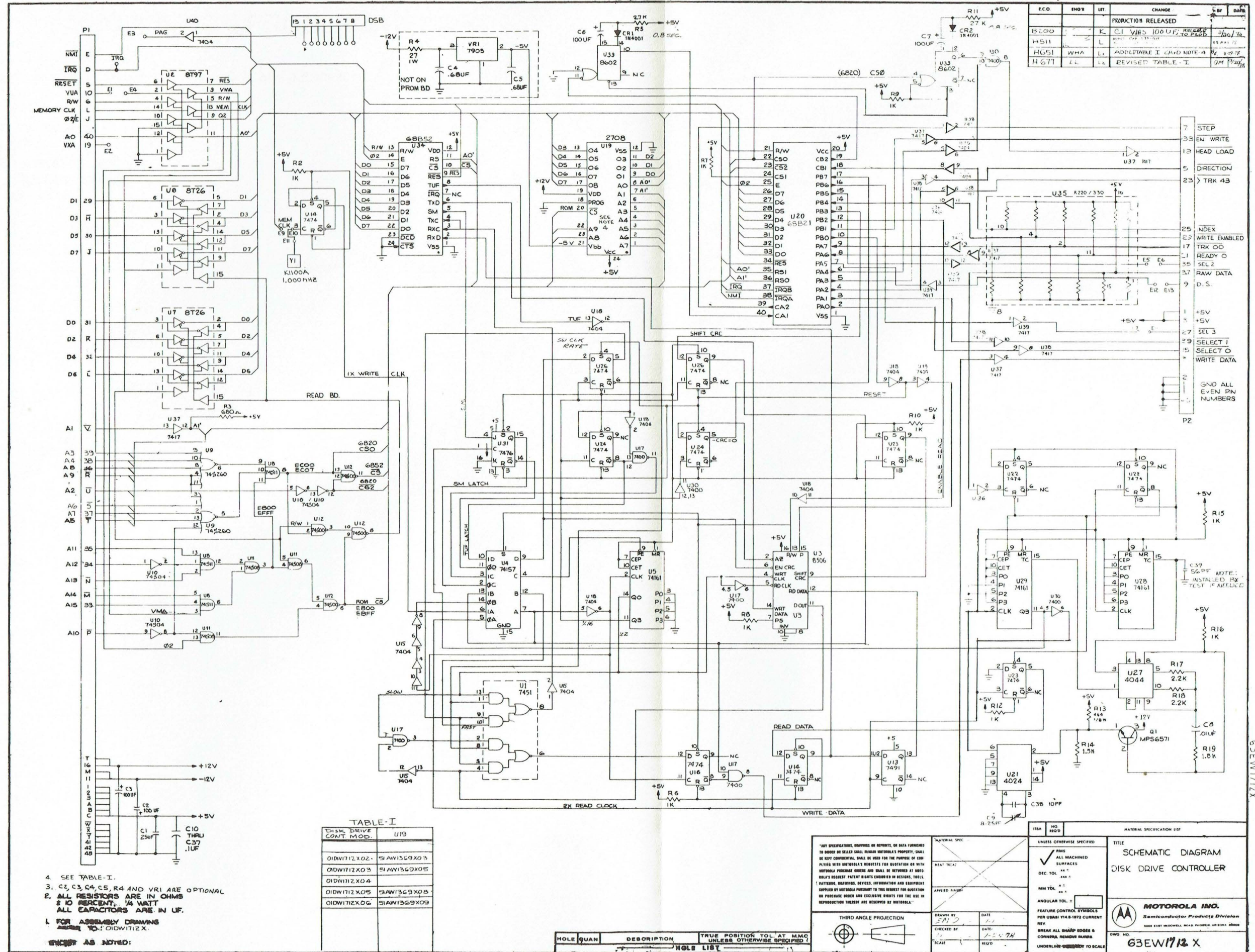


FIGURE 4-4. M68SFDC2/3 and M6809FDCONT2/3 Floppy Disk Controller Module,
Parts Location

4.5 SCHEMATIC DIAGRAM

Figure 4-5 illustrates the schematic diagram for the Floppy Disk Controller Module.

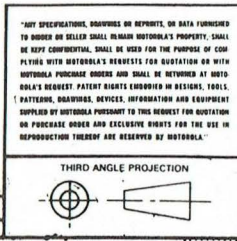


ECO	ENG'S	LET.	CHANGE	BY	DATE
			PRODUCTION RELEASED		
B200		K	C1 VMS 100UF TO C26		7/20/76
H511		L			08 MAY 75
H651	WHA	L	ADDED TABLE I C100 NOTE 4		8/19/78
H677	LL	LL	REVISED TABLE-I		9/4/79

DISK DRIVE CONT. MOD.	U19
01DW1712X02	51AW1369X03
01DW1712X03	51AW1369X05
01DW1712X04	51AW1369X08
01DW1712X05	51AW1369X0B
01DW1712X06	51AW1369X09

- SEE TABLE-I.
- C2, C3, C4, C5, R4 AND VRI ARE OPTIONAL
- ALL RESISTORS ARE IN OHMS
± 10 PERCENT, 1/4 WATT
ALL CAPACITORS ARE IN UF.
- FOR ASSEMBLY DRAWING
REFER TO: 01DW1712X.

HOLE QUAN	DESCRIPTION	TRUE POSITION TOL. AT MMC UNLESS OTHERWISE SPECIFIED
		HOLE LIST



ITEM	NO	REQD	MATERIAL SPECIFICATION LIST
UNLESS OTHERWISE SPECIFIED			
✓	FRAME		ALL MACHINED SURFACES
	DEC. TOL.		MM TOL.
	ANGULAR TOL.		
FEATURE CONTROL SYMBOLS PER USASI Y14.8-1973 CURRENT REV.			
BREAK ALL SHARP EDGES & CORNERS, REMOVE BURRS			
UNDERLINE DIMENSIONS TO SCALE			

DRAWN BY: <i>EMD</i>		DATE: <i>7-1-74</i>
CHECKED BY: <i>...</i>		DATE: <i>...</i>
SCALE: <i>...</i>		REQD: <i>...</i>
 MOTOROLA INC. Semiconductor Products Division <small>300 EAST WISCONSIN AVENUE, CHICAGO, ILLINOIS 60601</small>		
63EW1712 X		

FIGURE 4-5. Floppy Disk Controller Module Schematic Diagram